

# **Excellent Integrated System Limited**

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Rohm Semiconductor MCH185A0R5CK

For any questions, you can email us directly: <a href="mailto:sales@integrated-circuit.com">sales@integrated-circuit.com</a>



Ceramic capacitors

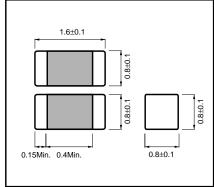
# Multi-layer ceramic chip capacitors

# MCH18 (1608 (0603) size, chip capacitor)

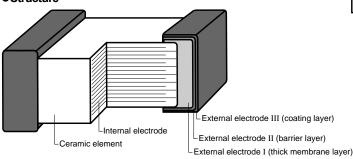
#### Features

- 1) Small size (1.6 x 0.8 x 0.8 mm) makes it perfect for lightweight portable devices.
- Comes packed either in tape to enable automatic mounting or in bulk cases.
- Precise uniformity of shape and dimentions highly efficient automatic mounting.
- Barrier layer and end terminations to improve solderability.

#### ●External dimensions (Units : mm)



#### Structure



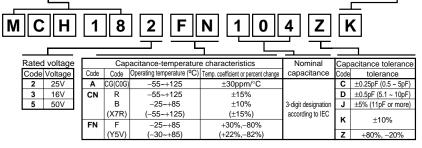
#### Product designation

Part No.

Code	Product thickness	Packaging specifications	Reel	Basic ordering (pcs.)
K	0.8mm	Paper tape (width 8 mm, pitch 4 mm)	φ180mm (7in.)	4,000
L	0.8mm	Paper tape (width 8 mm, pitch 4 mm)	φ330mm (13in.)	16,000
С	0.8mm	Bulk case	-	15,000

Ree I(\phi180,\phi330mm): compatible with EIAJ ET-72





<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.





## Ceramic capacitors

#### ● Capacitance range

For thermal compensation

Part number. MCH18					
Fait flui					
Capacitance(pF)	Temperature characteristics  Rated voltage	A (CG) (C0G)			
,	Tolerance (V)	50			
0.5		<b>****</b>			
0.75 1					
1.1					
1.2 1.3					
1.5		<b>****</b>			
1.6 1.8					
2					
2.2 2.4	C ( ± 0.25pF)				
2.7					
3 3.3					
3.6 3.9					
4					
4.3 4.7		×××××			
5					
5.1					
5.6 6	- D ( ± 0.5pF)				
6.2					
6.8 7					
7.5		<b>*****</b>			
8 8.2					
9					
9.1 10					
11 12					
13					
15 16		××××			
18					
20 22					
24					
27		×××××			
30 33	1 ( + 5%)				
36	J (±5%)				
39 43					
47					
51 56					
62					
68 75					
82					
91 100					

Part nur	MCH18	
	Temperature characteristics	A (CG) (C0G)
Capacitance (pF)	Rated voltage Tolerance (V)	50
110		
120		××××
130		
150		
160		<b>*******</b>
180		<b>******</b>
200		
220		
240		<b>*******</b>
270		<b>******</b>
300	J ( ± 5%)	
330		<b>******</b>
360		
390		
430		<b>******</b>
470		<b>******</b>
510		<b>******</b>
560		
620		<b>******</b>
680		
750		
820		××××
910		
1,000		

Product thickness (mm) 0.8 ± 0.1

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.



# Distributor of Rohm Semiconductor: Excellent Integrated System Limited

Datasheet of MCH185A0R5CK - CAP CER 0.50PF 50V NP0 0603

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MCH18

## Ceramic capacitors

High dielectric constant

Part number		MCH18				
Canacitanas(-F)	Temperature characteristics	CN (R) (B) (X7R)		FN (F) (Y5V)		
Capacitance(pF)	Rated voltage (V)	50	25	50	25	16
	Tolerance	K (±	10%)	Z	(+80%, <i>–</i> 20	%)
220		<b>*****</b>				
270 330						
390						
470 560						
680						
820						
1,000						
1,200 1,500						
1,800						
2,200				<b>*****</b>		
2,700 3,300						
3,900						
4,700						
5,600 6,800						
8,200		10000000				
10,000 (0.01μF)						
12,000 15,000						
18,000						
22,000						
27,000 33,000						
39,000						
47,000			<b>*****</b>	<b>****</b>		
56,000			<b>******</b>			
68,000 82,000						
100,000 (0.1μF)						
120,000 150,000						
180,000						
220,000						<b>*****</b>
270,000 330,000						
390,000						
470,000						
560,000						
680,000 1,000,000 (1μF) 1,200,000						
1,500,000						
1,800,000						
2,200,000						

Product thickness (mm) 0.8 ± 0.1



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MCH18

# Ceramic capacitors

#### Characteristics

Class 1 (For thermal compensation)

Temperature characteristics		A (CG) (C0G)	Test methods / conditions (based on JIS C 5102)	
		(55) (555)		
Operating temperature		−55°C ~ +125°C		
Nominal capacitance (C)		Must be within the specified tolerance range.	Based on paragraph 7.8 and paragraph 9 Measured at room temperature and standard humi 1000pF or less Measurement frequency : 1± 0.1M	
Dissipation factor $(\tan \delta)$		100 / (400 + 20C)% or less (Less than 30 pF) 0.1% or less (30 pF or larger)	Measurement voltage : 1± 0.1Vrm Over 1000pF Measurement frequency : 1± 0.1kHz Measurement voltage : 1± 0.1Vrm	
Insulation resistance (IR)		10,000MΩ or 500MΩ·μF , whichever is smaller	Based on paragraph 7.6 Measurement is made after rated voltage is applied for $60 \pm 5s$ .	
Withstanding voltage		The insulation must not be damaged.	Based on paragraph 7.1 Apply 300% of the rated voltage for 1 to 5s then measure.	
Temperature ch	naracteristics	Within 0 ± 30ppm / °C	The temperature coefficients in table 12, paragraph 7.12 are calculated at 20°C and high temperature.	
Terminal adherence		No detachment or signs of detachment.	Based on paragraph 8.11.2 Apply 5N for 10 ± 1s in the direction indicated by the arrow.  Pressure (5N) Capacitor Capacitor	
	Appearance	There must be no mechanical damage.	Chip is mounted to a board in the	
Resistance to vibration	Rate of capacitance change	Must be within initial tolerance.	to vibration (type A in paragraph 8.2),	
-	Dissipation factor (tanδ)	Must satisfy initial specified value.	and measured 24 ± 2 hrs. later. Board	
Solderability		At least 3 / 4 of the surface of the two terminals must be covered with new solder.	$\begin{array}{c} \text{Based on paragraph 8.13} \\ \text{Soldering temperature}: 235 \pm 5^{\circ}\text{C} \\ \text{Soldering time} & : 2 \pm 0.5\text{s} \end{array}$	
	Appearance	There must be no mechanical damage.		
	Rate of capacitance change	$\pm2.5\%$ or $\pm0.25~\text{pF}$ , whichever is larger.	Based on paragraph 8.14	
Resistance to soldering	Dissipation factor (tanδ)	Must satisfy initial specified value.	Soldering temperature : $260 \pm 5^{\circ}$ C Soldering time : $5 \pm 0.5$ s	
heat	Insulation resistance	$10,\!000M\Omega$ or $500M\Omega\!\cdot\!\mu F$ , whichever is smaller	Preheating : 150 ± 10°C for 1 to 2 min.	
	Withstanding voltage	The insulation must not be damaged.	1.02.1111.	
	Appearance	There must be no mechanical damage.		
Temperature	Rate of capacitance change	$\pm~2.5\%\pm0.25~\text{pF}$ , whichever is larger.	Based on paragraph 9.3	
cycling	Dissipation factor (tanδ)	Must satisfy initial specified value.	Number of cycles : 5 Capacitance measured after 24 ± 2 hrs.	
	Insulation resistance	10,000MΩ or 500MΩ·μF , whichever is smaller		
Humidity load - test	Appearance	There must be no mechanical damage.	Based on paragraph 9.9	
	Rate of capacitance change	$\pm$ 7.5% or $\pm$ 0.75 pF , whichever is larger.	Test temperature : 40 ± 2°C Relative humidity : 90% to 95%	
	Dissipation factor (tanδ)	0.5% or less	Applied voltage : rated voltage Test time : 500 to 524 hrs.	
	Insulation resistance	500M $\Omega$ or 25M $\Omega$ ·μF , whichever is smaller	Capacitance measured after 24 ± 2 hrs.	
High- temperature load test	Appearance	There must be no mechanical damage.	Rosed on paragraph 0.10	
	Rate of capacitance change	$\pm~3.0\%$ or $\pm~0.3~\text{pF}$ , whichever is larger.	Based on paragraph 9.10  Test temperature: Max. operating temp	
	Dissipation factor (tanδ)	0.3% or less	Applied voltage : rated voltage × 200% Test time : 1,000 to 1,048 hrs.	
	Insulation resistance	1,000M $\Omega$ or 50M $\Omega$ ·μF , whichever is smaller	Capacitance measured after 24 ± 2 hrs.	

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Datasheet of MCH185A0R5CK - CAP CER 0.50PF 50V NP0 0603

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MCH18

## Ceramic capacitors

#### Class 2 (High dielectric constant)

	- · · · · ·				
Temperature characteristics		CN (R) (B) (X7R)	FN (F) (Y5V)	Test methods/conditions (based on JIS C 5102)	
Operating temperature		−55°C ~ +125°C	−30°C ~ +85°C		
Nominal capacitance (C)		Must be within the specified tolerance range.		Measured at room temperature and standard humidity Measurement frequency: 1 ± 0.1 kHz Measurement voltage : 1.0 ± 0.2 Vrms.	
Dissipation factor (tanδ)		2.5% or less when rated voltage is 16V: 3.5% or less) (when rated voltage is 16V: 7.5% or less			
Insulation resistance (IR)		10,000 MΩ or 500 MΩ · $\mu$ F, whichever is smaller		Based on paragraph 7.6 Measurement is made after rated voltage is applied for $60 \pm 5s$ .	
Withstanding voltage		The insulation must not be damaged.		Based on paragraph 7.1 Apply 250% of the rated voltage for 1 to 5s then measu	
Temperature characteristics		Within ± 15%	+ 22, + 82%	The temperature coefficients in paragraph 7.12, table 8, condition B, are based on measurements carried out at 20°C, with no voltage applied.	
Terminal adherence		No detachment or signs of detachment		Based on paragraph 8. 11. 2.  Apply 5N for 10 ± 1s in the direction indicated by the arrow.  Pressure (5)  Capacitor	
	Appearance	There must be no mechanical damage.		Chip is mounted to a board in the	
Resistance to vibration	Rate of capacitance change	e Must be within initial tolerance.		manner shown on the right, subjected to vibration (type A in paragraph 8.2),	
	Dissipation factor (tanδ)	Must satisfy initial specified value.		and measured 48 ± 4 hrs. later. Board	
Solderability		At least 3/4 of the surface of the two terminals must be covered with new solder.		Based on paragraph 8. 13 Soldering temperature: $235 \pm 5^{\circ}\text{C}$ Soldering time : $2 \pm 0.5\text{s}$	
	Appearance	There must be no mechanical damage.			
Ī	Rate of capacitance change	Within ± 5.0% Within ± 20.0%			
Resistance to soldering	Dissipation factor (tanδ)	Must satisfy initial specified value.		Based on paragraph 8. 14. Soldering temperature: 260 ± 5°C	
heat	Insulation resistance	10,000MΩ or 500MΩ $\cdot$ μF, whichever is smaller		Soldering time $: 5 \pm 0.5s$ Preheating $: 5 \pm 0.5s$ $: 150 \pm 10^{\circ}\text{C}$ for 1 to 2 min.	
ĺ	Withstanding voltage	The insulation must not be damaged.			
	Appearance	There must be no mechanical damage.			
Temperature	Rate of capacitance change	Within ± 7.5%	Within ± 20.0%	Based on paragraph 9.3	
cycling	Dissipation factor (tanδ)	Must satisfy initial specified value.		Number of cycles : 5 Capacitance measured after 48 $\pm$ 4 hr	
	Insulation resistance	10,000MΩ or 500MΩ $\cdot$ μF, whichever is smaller		1	
	Appearance	There must be no mechanical damage.		Based on paragraph 9.9	
	Rate of capacitance change	± 12.5% or less	Within ± 30.0%	Test temperature: 40 ± 2°C	
Humidity load test	Dissipation factor (tanδ)	5.0% or less	7.5% or less (when rated voltage is 16V: 10.0%)	Relative humidity: 90% to 95% Applied voltage : rated voltage Test time : 500 to 524 hrs.	
	Insulation resistance	500MΩ or 25MΩ · μF, whichever is smaller		Capacitance measured after 48 ± 4 hr	
High- temperature load test	Appearance	There must be no mechanical damage.			
	Rate of capacitance change	Within ± 10.0%	Within ± 30.0%	Based on paragraph 9.10	
	Dissipation factor (tanδ)	5.0% or less	7.5% or less (when rated voltage is 16V: 10.0%)	Test temperature: Max. operating tem Applied voltage : rated voltage × 200 Test time : 1,000 to 1,048 hrs.	
	Insulation resistance	1,000MΩ or 50MΩ · μ	F, whichever is smaller	Capacitance measured after 48 ± 4	

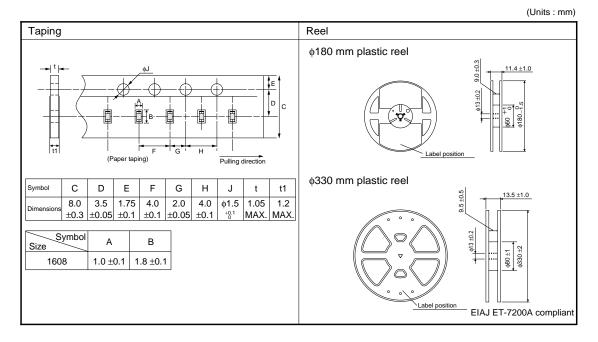
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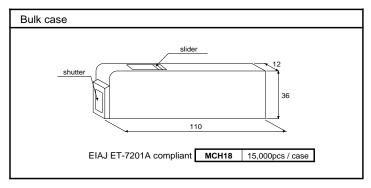




## Ceramic capacitors

#### Packaging specifications





## Ceramic capacitors

#### Electrical characteristics

#### ■ A (C0G) Characteristics

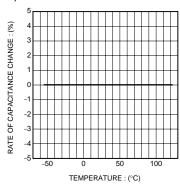


Fig.1 Capacitance - temperature characteristics

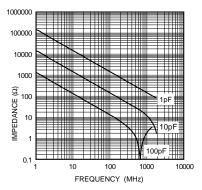


Fig.2 Impedance - frequency characteristics

#### ■CN (X7R) Characteristics

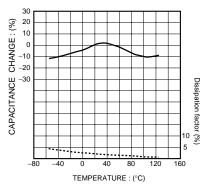


Fig.3 Capacitance - temperature characteristics

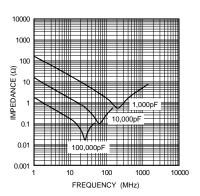


Fig.4 Impedance - frequency characteristics

#### ■FN (Y5V) Characteristics

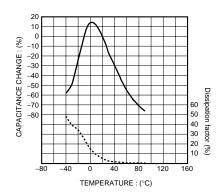


Fig.5 Capacitance - temperature characteristics

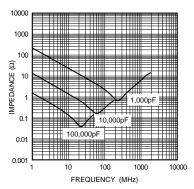


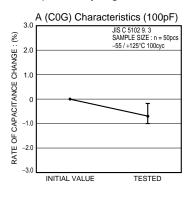
Fig.6 Impedance - frequency characteristics

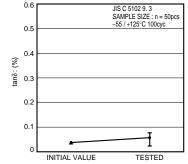
<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.



## Ceramic capacitors

#### ■ Temperature cycling test





0.6

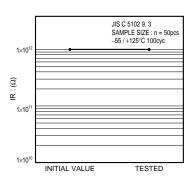
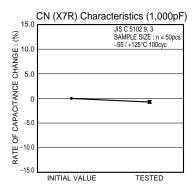
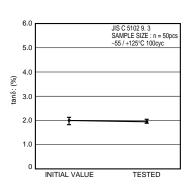


Fig.7 Rate of capacitance change

Fig.8 tanδ

Fig.9 Insulation resistance





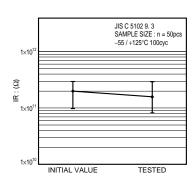
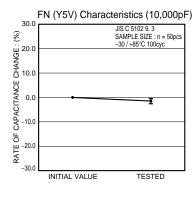
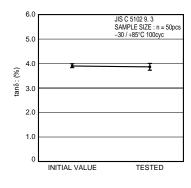


Fig.10 Rate of capacitance change

Fig.11 tanδ

Fig.12 Insulation resistance





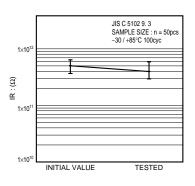


Fig.13 Rate of capacitance change

Fig.14  $tan\delta$ 

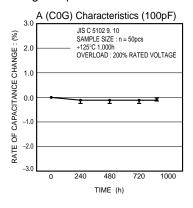
Fig.15 Insulation resistance

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## Ceramic capacitors

#### ■ High-temperature load test





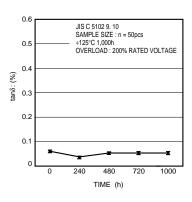


Fig.17 tanδ

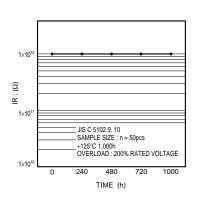


Fig.18 Insulation resistance

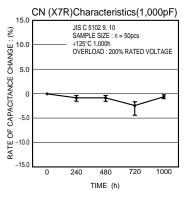


Fig.19 Rate of capacitance change

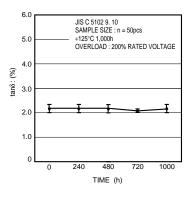


Fig.20  $\tan \delta$ 

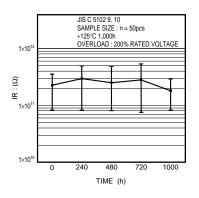


Fig.21 Insulation resistance

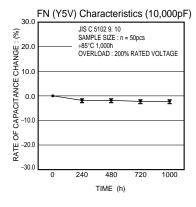


Fig.22 Rate of capacitance change

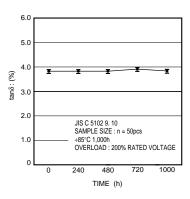


Fig.23 tanδ

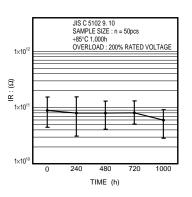


Fig.24 Insulation resistance

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## Ceramic capacitors

#### ■ Humidity load test

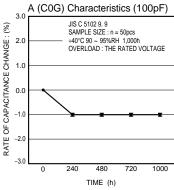




Fig.25 Rate of capacitance change

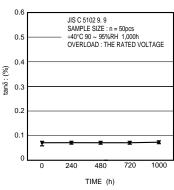


Fig.26  $\tan \delta$ 

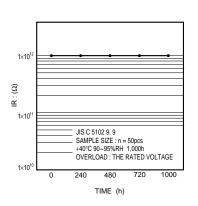


Fig.27 Insulation resistance

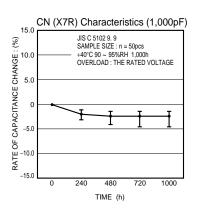


Fig.28 Rate of capacitance change

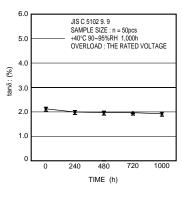


Fig.29 tanδ

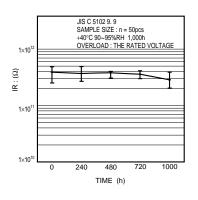


Fig.30 Insulation resistance

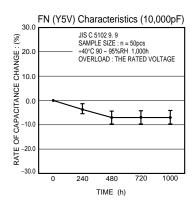


Fig.31 Rate of capacitance change

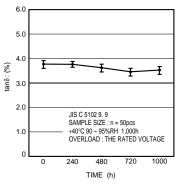


Fig.32 tanδ

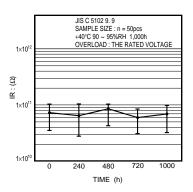


Fig.33 Insulation resistance

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